

PATENT ASSIGNMENT COVER SHEET

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| SUBMISSION TYPE: | NEW ASSIGNMENT |
| NATURE OF CONVEYANCE: | ASSIGNMENT |
| CONVEYING PARTY DATA | |
| Name | Execution Date |
| MOHAMED N. DARWISH | 01/17/2020 |
| RECEIVING PARTY DATA | |
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| City: | SAN JOSE |
| State/Country: | CALIFORNIA |
| Postal Code: | 95110 |
| PROPERTY NUMBERS Total: 1 | |
| Property Type | Number |
| Patent Number: | 7843004 |
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| NAME OF SUBMITTER: | GWENDOLYN G. CORCORAN |
| SIGNATURE: | /Gwendolyn G. Corcoran/ |
| DATE SIGNED: | 11/30/2020 |
| Total Attachments: 2 | |
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ASSIGNMENT

As a below-named inventor of U.S. patent application 11/903,972 filed September 25, 2007, now issued as U.S. 7,843,004, entitled "Power MOSFET With Recessed Field Plate" (attorney docket number MXP-007, nominally DSH003 US), which names an inventorship of Mohamed N. Darwish, I hereby sell, assign and transfer to MaxPower Semiconductor, Inc., (hereinafter referred to as ASSIGNEE), for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the full and exclusive right, title, and interest to said invention in the United States and its territorial possessions and in all foreign countries and to all Letters Patent or similar legal protection in the United States and its territorial possessions and in all foreign countries to be obtained for said invention by said application or any division, continuation, continuation-in-part, renewal, substitute, extension, re-examination, reissue, or any other patent application which claims any priority in common with the present application, including without limitation any legal equivalent thereof in the United States or any foreign country or national or regional patent authority, for the full term or terms of which the same may be granted, and specifically including the right to file international and foreign national or regional applications and claim priority to this application therefor under the provisions of any convention or treaty;

and I also hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale;

and I further hereby covenant that I will, upon ASSIGNEE'S request, promptly provide ASSIGNEE with all pertinent facts and documents, relating to said application, to any invention disclosed therein, or to any of said Letters Patent or legal equivalents thereof in the United States or in foreign countries, as may be known and accessible to me, and that I will testify and give evidence as to the same in any litigation or interference which may arise, and that I will promptly execute and deliver to ASSIGNEE or its legal representative, without charge but at Assignee's expense, any and all papers, instruments or affidavits which may be required, necessary or desirable for the purpose of applying for, obtaining, maintaining, issuing or enforcing said application and said Letters Patent and said equivalents thereof in the United States or in any foreign country; and I further authorize ASSIGNEE or its legal representative to make any submissions or true declarations which may be needed in connection with the prosecution of this application or related applications in the U.S. or in other countries, consistent with

the requirements of the applicable country;

AND I HEREBY AUTHORIZE AND REQUEST the issuing authority to issue any and all United States and foreign national or regional patent documents or grants related to this application and/or invention to ASSIGNEE, its successors and assigns.

IN WITNESS WHEREOF, this Assignment has been executed on the date set forth below.

Inventor: Mohamed N. Darwish

Date: 1-17-2020 Signature: Mohamed N. darwish
Residence: Campbell, California, USA